

Skúšobná metóda na opotrebovanie prostriedkov na mäkké spájkovanie vlnou využívajúce roztavenú bezolovnatú spájkovaciu zliatinu Časť 3: Návod na výber skúšobnej metódy na hodnotenie opotrebovania

STN EN 62739-3

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Test method for erosion of wave soldering equipment using molten lead-free solder alloy - Part 3: Selection guidance of erosion test methods

Táto norma obsahuje anglickú verziu európskej normy. This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 07/17

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#### **English Version**

Test method for erosion of wave soldering equipment using molten lead-free solder alloy - Part 3: Selection guidance of erosion test methods
(IEC 62739-3:2017)

Méthode d'essai de l'érosion de l'équipement de brasage à la vague utilisant un alliage à braser sans plomb fondu - Partie 3: Document d'orientation pour le choix des méthodes d'essai d'érosion (IEC 62739-3:2017)

Verfahren zur Erosionsprüfung für Wellenlötausrüstungen bei Verwendung von geschmolzener, bleifreier Lotlegierung - Teil 3: Leitfaden für die Auswahl von Verfahren zur Erosionsprüfung (IEC 62739-3:2017)

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The text of document 91/1368/CDV, future edition 1 of IEC 62739-3, prepared by IEC/TC 91 "Electronics assembly technology" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 62739-3:2017.

The following dates are fixed:

•	latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement	(dop)	2017-11-10
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### Annex ZA

(normative)

# Normative references to international publications with their corresponding European publications

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NOTE 1 When an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: <a href="https://www.cenelec.eu">www.cenelec.eu</a>

<u>Publication</u>	<u>Year</u>	<u>Title</u>	EN/HD	<u>Year</u>
IEC 60068-2-20	2008	Environmental testing - Part 2-20: Tests - Test T: Test methods for solderability and resistance to soldering heat of devices with leads	EN 60068-2-20	2008
IEC 61190-1-3	-	Attachment materials for electronic assembly - Part 1-3: Requirements for electronic grad solder alloys and fluxed and non-fluxed solid solders for electronic soldering applications	EN 61190-1-3 e	-
IEC 62739-1	2013	Test method for erosion of wave soldering equipment using molten lead-free solder alloy - Part 1: Erosion test method for metal materials without surface processing	EN 62739-1	2013
IEC 62739-2	-	Test method for erosion of wave soldering equipment using molten lead-free solder alloy - Part 2: Erosion test method for metal materials with surface processing	EN 62739-2	-



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Edition 1.0 2017-01

# INTERNATIONAL STANDARD

Test method for erosion of wave soldering equipment using molten lead-free solder alloy –

Part 3: Selection guidance of erosion test methods





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IEC 62739-3

Edition 1.0 2017-01

# INTERNATIONAL STANDARD

Test method for erosion of wave soldering equipment using molten lead-free solder alloy –

Part 3: Selection guidance of erosion test methods

INTERNATIONAL ELECTROTECHNICAL COMMISSION

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### CONTENTS

F	OREWO	)RD	4	
1	Scop	oe	6	
2	Norn	native references	6	
3	Term	ns and definitions	6	
4	Gene	eral remarks	7	
5	Selection of the appropriate erosion test method			
	5.1	Correlation between test methods and stresses induced in the field		
	5.2	Recommended test method by materials		
6	Com	mon items for each test method	10	
	6.1	Specimen preparation	10	
	6.2	Solder alloy	10	
	6.3	Accelerated stress conditions	10	
	6.3.1	Test temperature	10	
	6.3.2	Rotation speed	10	
	6.3.3			
	6.4	Dross		
	6.4.1	ŭ		
	6.4.2			
	6.4.3			
	6.5	Erosion depth measurement method		
	6.5.1			
	6.5.2	1		
	6.5.3			
_	6.5.4			
7		view of the test methods		
	7.1	Test methods		
	7.2	Metal material without surface processing		
	7.2.1			
	7.2.2			
	7.3	Metal material with surface processing		
	7.3.1 7.3.2			
	7.3.2			
٨		(informative) Selection of test temperature, test duration and bending stress		
$\overline{}$		·		
	A.1 A.2	Specimen without surface processing		
٨		(informative) Maximum depth and other measurements		
^		General		
	B.1			
٨	B.2	Maximum depth measurement(informative) Erosion mechanism		
^		· · · · · · · · · · · · · · · · · · ·		
	C.1 C.2	Specimen without surface processing		
	C.2 C.3	Specimen with surface processing  Further guidance		
Λ		(informative) Thermal acceleration for erosion		
$\overline{}$		· · · · · · · · · · · · · · · · · · ·		
	D.1	Specimen with surface processing		
	D.2	Specimen with surface processing	∠8	

D.3 Further guidance document	30
Bibliography	31
Figure 1 – Schematic example of wave soldering equipment	Q
Figure 2 – Example of dross removal tool	
Figure 3 – Schematic general definition of erosion depth	
Figure 4 – Schematic definition of erosion depth by focal depth method	
Figure 5 – Examples of local erosion	
Figure 6 – Example of evaluation region	
Figure 7 – Examples with non-erosion area	
Figure 8 – Examples without a non-erosion area and an example of a cross section	
Figure 9 – Configuration example of test equipment	15
Figure 10 – Configuration example of test equipment for rotation test at 450 °C with 2 mm bending	17
Figure A.1 – Specimen configuration for preliminary test	18
Figure A.2 – Erosion depth against molten solder temperature	19
Figure A.3 – Erosion depth against rotation speed	19
Figure A.4 – Erosion depth against immersion time	20
Figure C.1 – Erosion mechanism for material with nitriding	27
Figure D.1 – Tin (Sn) diffusion layer growth in the plasma nitriding layer for various	00
stainless steel	29
Table 1 – Location of erosion in the field and examples of problems	8
Table 2 – Correlation between test methods and stresses induced in the field	9
Table 3 – Applicable test method depending on the materials	9
Table 4 – Test conditions for rotation test at 350 °C	16
Table 5 – Test conditions for rotation test at 350 °C	16
Table A.1 – Erosion test results for the materials of gas nitriding and nitrocarburizing	21
Table A.2 – Erosion test results for the materials of coating type surface processing	22
Table B.1 – Measurement methods, features and accuracy	24
Table B.2 – Example of measurement equipment	25
Table D.1 – Plasma nitriding layer peeling off period (incubation period in Figure D.1)	29
Table D.2 – Initial growth rate for tin (Sn) diffusion layer	30

#### INTERNATIONAL ELECTROTECHNICAL COMMISSION

TEST METHOD FOR EROSION OF WAVE SOLDERING EQUIPMENT USING MOLTEN LEAD-FREE SOLDER ALLOY –

### Part 3: Selection guidance of erosion test methods

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International Standard IEC 62739-3 has been prepared by IEC technical committee 91: Electronics assembly technology.

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CDV	Report on voting
91/1368/CDV	91/1400/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

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– 5 –

A list of all the parts in the IEC 62739 series, under the general title *Test method for erosion* of wave soldering equipment using molten lead-free solder alloy, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

### TEST METHOD FOR EROSION OF WAVE SOLDERING EQUIPMENT USING MOLTEN LEAD-FREE SOLDER ALLOY –

#### Part 3: Selection guidance of erosion test methods

#### 1 Scope

This part of IEC 62739 describes the selection methodology of an appropriate evaluating test method for the erosion of the metal materials without or with surface processing intended to be used for lead-free wave soldering equipment as a solder bath and other components which are in contact with the molten solder.

#### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-2-20:2008, Environmental testing – Part 2-20: Tests – Test T: Test methods for solderability and resistance to soldering heat of devices with leads

IEC 61190-1-3, Attachment materials for electronic assembly – Part 1-3: Requirements for electronic grade solder alloys and fluxed and non-fluxed solid solder for electronic soldering applications

IEC 62739-1:2013, Test method for erosion of wave soldering equipment using molten lead-free solder alloy – Part 1: Erosion test method for metal materials without surface processing

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